

Description

The XpressKleen™ G2 filter advances PTFE membrane filtration to enable semiconductor makers to meet the critical chemical filtration requirements of leading edge device manufacturing processes. The XpressKleen filter provides control of critical size particles as well as maintaining critical fluid purity with a guarantee of less than 3 ppb of total metal ion extractables per single length filter¹. The XpressKleen filter's surface cleanliness includes removal of organic contamination and surface particles. This make the filter suitable for use from the point of supply (POS) to point of process (POP) to help define a contamination control system that delivers the required fluid purity to the wafer.

This is accomplished by Pall's completely integrated manufacturing capability that extends from the PTFE resin to the finished filter device. Pall's advanced manufacturing process (AMP), incorporates the latest clean room manufacturing and state-of-the-art proprietary cleaning steps with improved statistical process control to ensure reliability and performance.

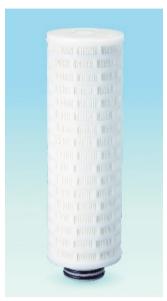
The XpressKleen G2 filter medium is made using Pall's proprietary Molecular Surface Tailoring (MST) technology. The nondewetting XpressKleen G2 filter is qualified for use in aggressive high temperature cleaning chemistries, including aqueous chemistries such as SC1 and SC2.

- Low extractables <3 ppb total of 13 elements
 <0.1ppb(Ni), <0.2ppb(Cu)
- >40nm particle rinse up control in UPW
- TOC control
- 100% prewetted shipment with ultrapure water package
- High flow rates
- G2 KC assembly available with downstream venting
- Disposable filter unit with filter cartridge integrally sealed in housing
- Sealed assembly for safer handling and faster changeout
- 100% integrity tested

XpressKleen™ G2 XpressKleen™ G2 KC

Surface-modified PTFE filter with ultimate initial cleanliness





Kleen-Change® (downstream venting)

Cartridge

Removal Ratings and Operating Conditions Kleen-Change® (KC)

Removal ratings	12nm	15	nm	30nm	50nm
Media code	XP12	XP15	XP15L	XP30	XPD
Filter area	2.2m ²	1.9m ²	3m ²	1.9m ²	2.2m ²
Flow		Flow Inli	ne, L-flow	, T-flow	
Maximum operating temperature		180	0°C / 356	°F	
Maximum operating pressure	0.49 MPaG (71 psig) @ 25°C (77°F) 0.39 MPaG (56.6 psig) @ 60°C (140°F) 0.34 MPaG (49.3 psig) @ 90°C (194°F) 0.20 MPaG (29.0 psig) @ 120°C (248°F) 0.15 MPaG (21.8 psig) @ 150°C (302°F) 0.12 MPaG (17.4 psig) @ 180°C (356°F)				

Cartridge

Removal R	atings	12nm	15	nm	30nm	50nm
Media Cod	е	XP12	XP15	XP15L	XP30	XPD
Filter Area	ABFG1	2.2m ²	1.9m ²	3m ²	1.9m ²	2.2m ²
	ABFG2	4.4m ²	3.8m ²	6m ²	3.8m ²	4.4m ²
Maximum (Temperatur		180°C / 356°F				
Maximum (Pressure	Operating	0.59 MPaG (85.6 psig) @ 50°C (120°F)		20°F)		

Total metal concentrations in 13 elements: Li, Na, Mg, Al, K, Ca, Cr, Mn, Fe, Ni, Cu, Zn, Pb, Consult factory for details.

Specifications²

Materials of Construction

Parts	Material
Filter medium	Surface-modified PTFE
Media support	PTFE / PFA
Core, cage and end caps	PFA
Housing	PFA
O-ring options ³	FEP-encapsulated fluoroelastomer

² All fluoropolymer materials are PFOA-free

Part Numbers / Ordering Information

XpressKleen G2 KC Asssemblies

LDF 1 2 1XP 3 4 E 5

Table 1

Code	Downstream vent
G	N / A
V	Available

Table 2

Code	Flow
Т	T-flow
N	In-line
L	L-flow

Table 4

Code	Inlet /	Vent / Drain		Type
	Outlet	Head End	Bowl End	
12	¾ in. male	½ in. male	½ in. male	T-flow / L-flow
12	¾ in. male	½ in. male	½ in. female	DV type
12	¾ in. male	¾ in. male	¾ in. male	In-line
124	¾ in. male	¼ in. male	½ in. male	In-line
128	¾ in. male	½ in. male	½ in. female	DV type
13	¾ in. male	½ in. female	½ in. female	T-flow
16	1 in. male	½ in. male	½ in. male	T-flow
16	1 in. male	½ in. male	½ in. female	DV type
16	1 in. male	% in. male	¾ in. male	In-line
164	1 in. male	¼ in. male	¼ in. male	In-line
168	1 in. male	½ in. male	½ in. male	DV type
17	1 in. female	½ in. female	½ in. female	In-line

DV: Downstream venting

XpressKleen G2 KC Asssemblies

ABFG 1 XP 2 3EH1

Table 1

Code	Length (nominal) inch mm	
1	10	225
2	20	468

Table 2

Code	Removal rating
12	12 nm
15	15 nm
15L	15 nm
30	30 nm
D	50 nm

Table 3

Code	Removal rating
12	12 nm
15	15 nm
15L	15 nm
30	30 nm
D	50 nm

Table 54

Code	Connections
1	20 series Flowell ⁵
2	Super Pillar type ⁶
51	Flare style
6	FinalLock ⁷
71	Super Pillar 300 P series
72	Super Pillar 300 P series L type
8	60 series Flowell
9	11CR series Flowell

 $^{^4}$ Disposable capsules are not available with every option. (Refer to codes for options.) Contact your local Pall representative for option availability.

 $^{^{}m 3}$ Consult factory for other options.

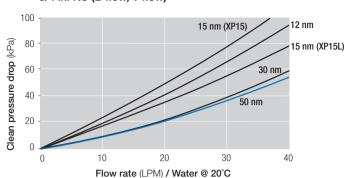
⁵ Flowell is a trademark of Flowell Corporation.

⁶ Super Pillar is a trademark of Nippon Pillar Packing Co., Ltd.

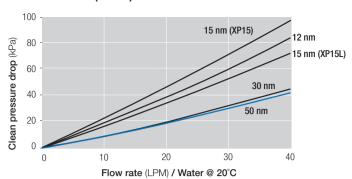
⁷ FinalLock is a trademark of Kurabo Industries Ltd.

Pressure Drop vs. Liquid Flow Rate8

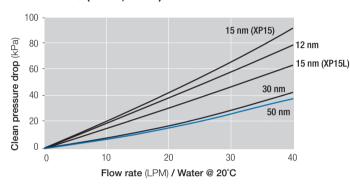
3/4 in. KC (L-flow, T-flow)



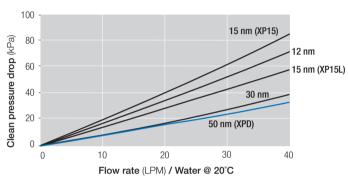
3/4 in. KC (In-line)



1 in. KC (In-line, T-flow)



10 in. cartridge



⁸ Typical flow rate. For liquids with a viscosity differing from water, multiply the pressure drop by the viscosity in centipoise.



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